

MAIL STOP AF PATENT 8026-1004

IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of:

Koki HIRASAWA et al.

Appl. No. 09/923,394

Filed August 8, 2001

LEAD FRAME, SEMICONDUCTOR DEVICE PRODUCED BY USING THE SAME AND METHOD OF PRODUCING THE SEMICONDUCTOR DEVICE

Conf. 2347

Group 2826

Examiner F. Erdem

AMENDMENT AFTER FINAL REJECTION

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 March 17, 2005

Sir:

In response to the Official Action mailed December 3, 2004, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 9 of this paper.